

**DATASHEET**

**ES-2835-1072V-XX-XXX**



## ES-2835-1072V-XX-XXX Datasheet

This 2835 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc.

This part has a foot print that is compatible to most of the same size LED in the market today.



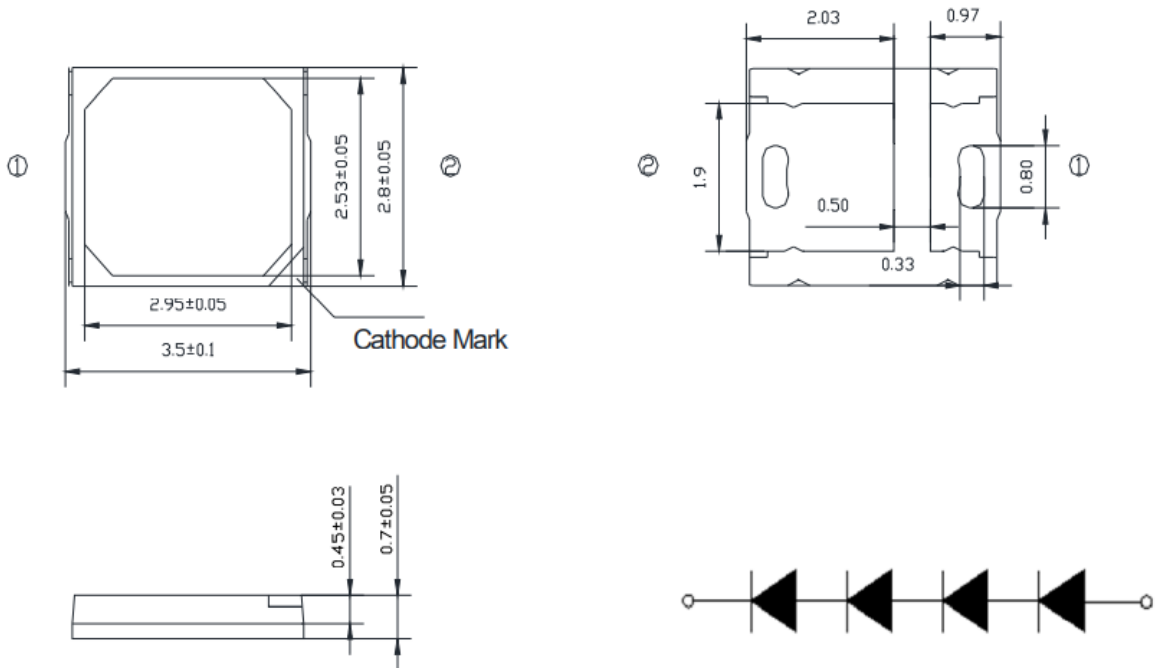
### FEATURES

- Available in Cool White, Neutral White and Warm White color
- ANSI-compatible chromaticity bins
- High luminous Intensity and high efficiency
- Compatible with reflow soldering process
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- Silicone encapsulation
- Environmental friendly, RoHS compliance

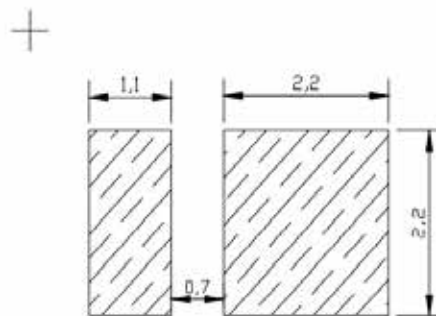
### APPLICATIONS

- LED tube light
- LED bulb light

## PACKAGE DIMENSIONS



## Recommended Solder Pad Design



### Notes:

1. All dimensions in millimeters.
2. Thickness tolerance of copper plate is  $\pm 0.02$  mm.
3. Thickness tolerance of product is  $\pm 0.05$  mm.
4. Tolerance is  $\pm 0.1$  mm unless otherwise noted.

## ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Absolute Maximum Rating	Unit
Forward current	$I_F$	15	mA
Peak Forward Current <sup>[1]</sup>	$I_{FP}$	18	mA
Reverse Voltage	$V_R$	5	V
Power Dissipation	$P_d$	1040	mW
Operating Temperature	$T_{opr}$	-40~+85	°C
Storage Temperature	$T_{stg}$	-40~+100	°C
Soldering Temperature	$T_{sld}$	Soldering: 260 °C for 10 seconds	
LED Junction Temperature	$T_j$	115	°C

$I_{FP}$  Conditions: Pulse Width ≤10msec. and Duty ≤1/10.

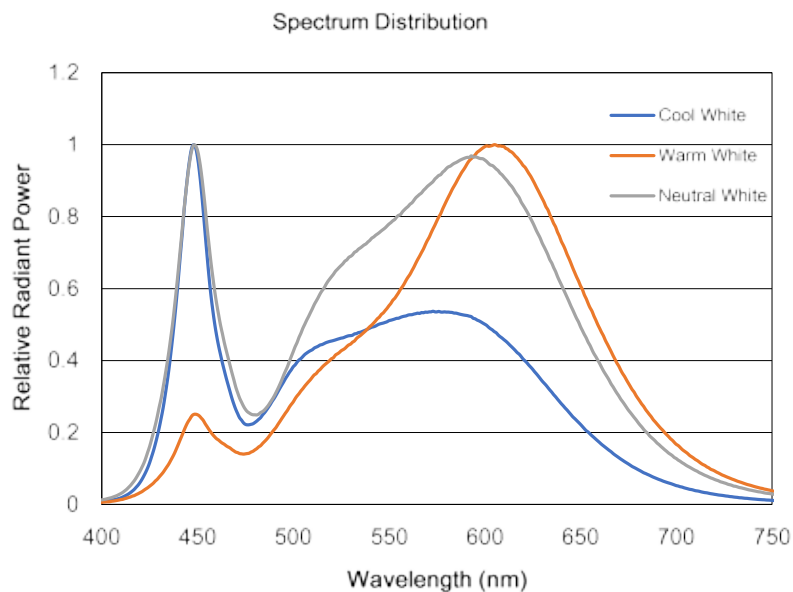
## CHARACTERISTICS (T<sub>j</sub>=25°C)

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	$V_F$	$I_F=15mA$	66	--	74	V
Viewing Angle	2θ <sub>1/2</sub>	$I_F=15mA$	--	120	--	deg.
Luminous Flux	Φ <sub>v</sub>	$I_F=15mA$	155	--	175	lm
Color Rendering Index	CRI	$I_F=15mA$	80	--	--	--
Color Temperature	CCT	$I_F=15mA$	2800	--	7000	K
Thermal Resistance (Junction to Solder point)	$R_{th-js}$	$I_F=15mA$	--	20	--	°C/W

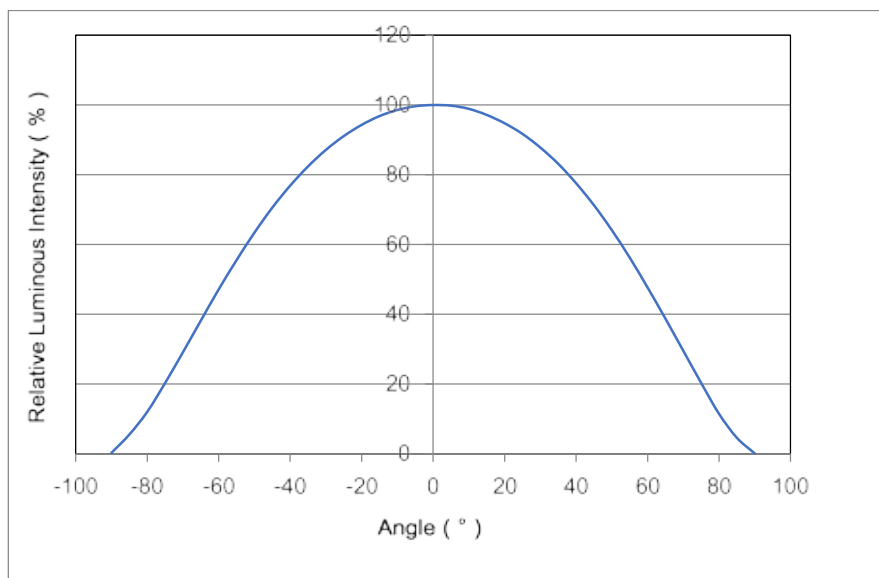
### Notes:

1. Luminous flux is measured with an accuracy of ± 10%.
2. Chromaticity coordinate bins are measured with an accuracy of ± 0.01.
3. CRI is measured with an accuracy of ± 2.
4. Some color and CRI bins may have limited availability, please contact us before ordering.
5. All measurements were made under the standardized environment of Everstar

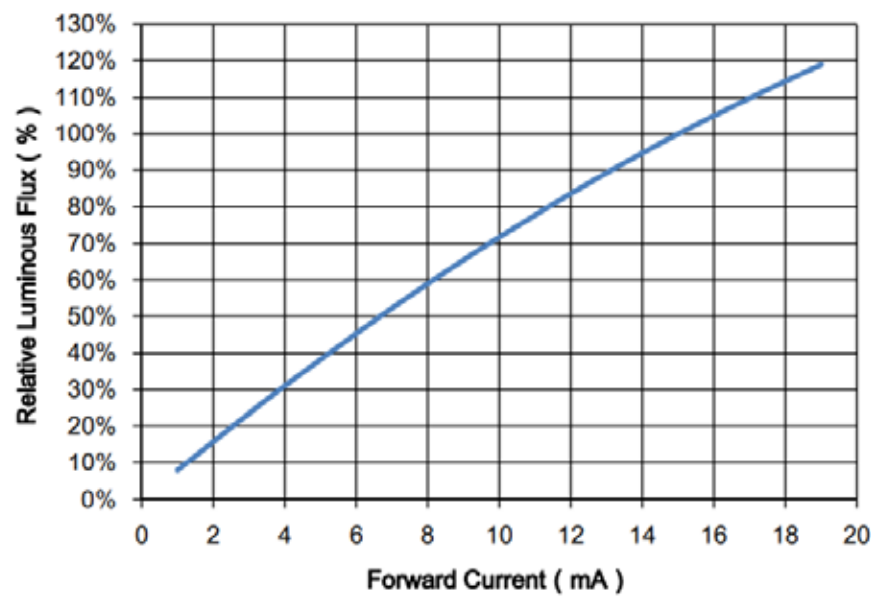
## RELATIVE SPECTRAL POWER DISTRIBUTION ( $T_j=25^{\circ}\text{C}$ )



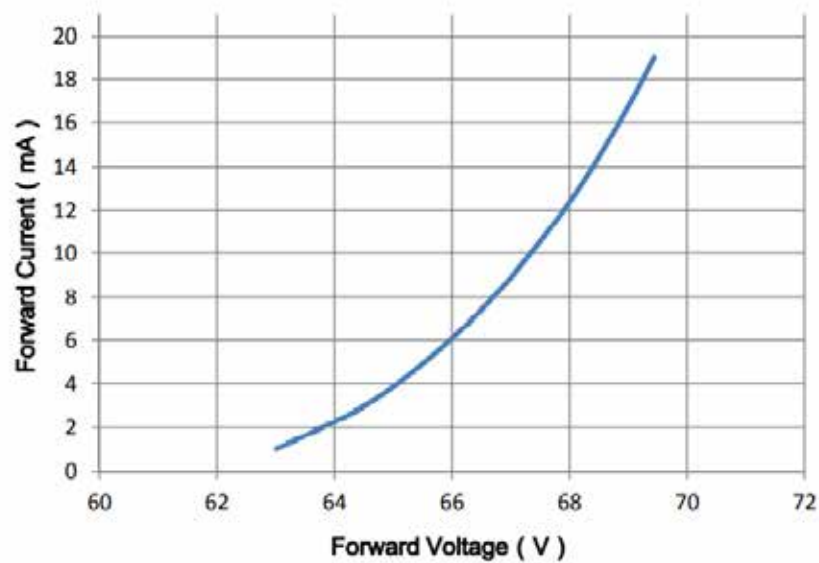
## TYPICAL SPATIAL DISTRIBUTION



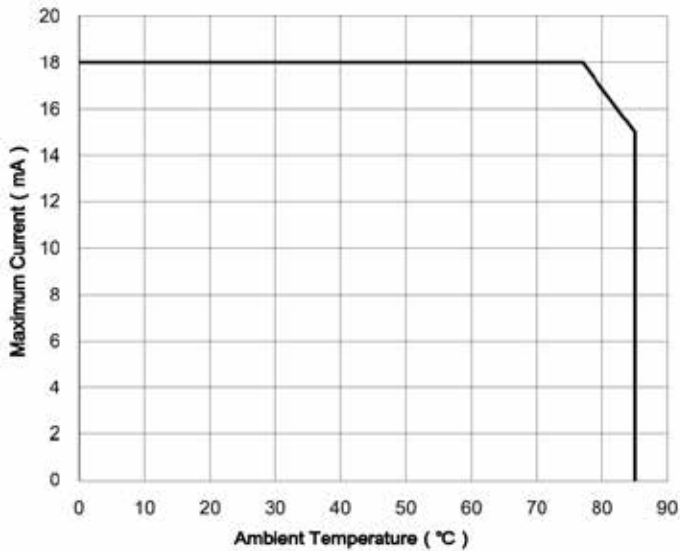
RELATIVE LUMINOUS FLUX VS.CURRENT (T<sub>j</sub>=25°C)



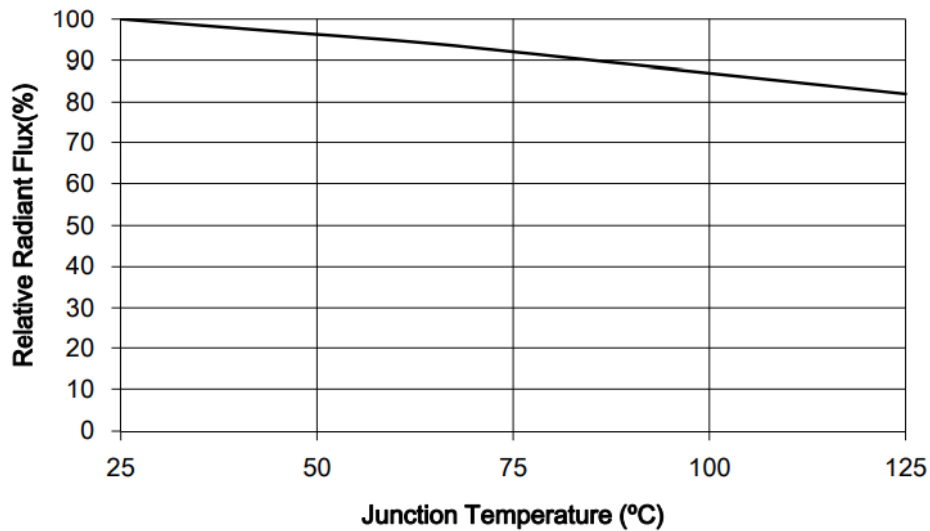
ELECTRICAL CHARACTERISTICS (T<sub>j</sub>=25°C)



## MAXIMUM CURRENT VS. AMBIENT TEMPERATURE



## RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE



SORTING RANKS

Part No.	Condition	Rank	Unit
ES-2835-1072V-XX-830	60mA	L2 155-165	Im
ES-2835-1072V-XX-840		L2 165-175	
ES-2835-1072V-XX-850		L2 165-175	
ES-2835-1072V-XX-857		L2 165-175	
ES-2835-1072V-XX-865		L2 165-175	

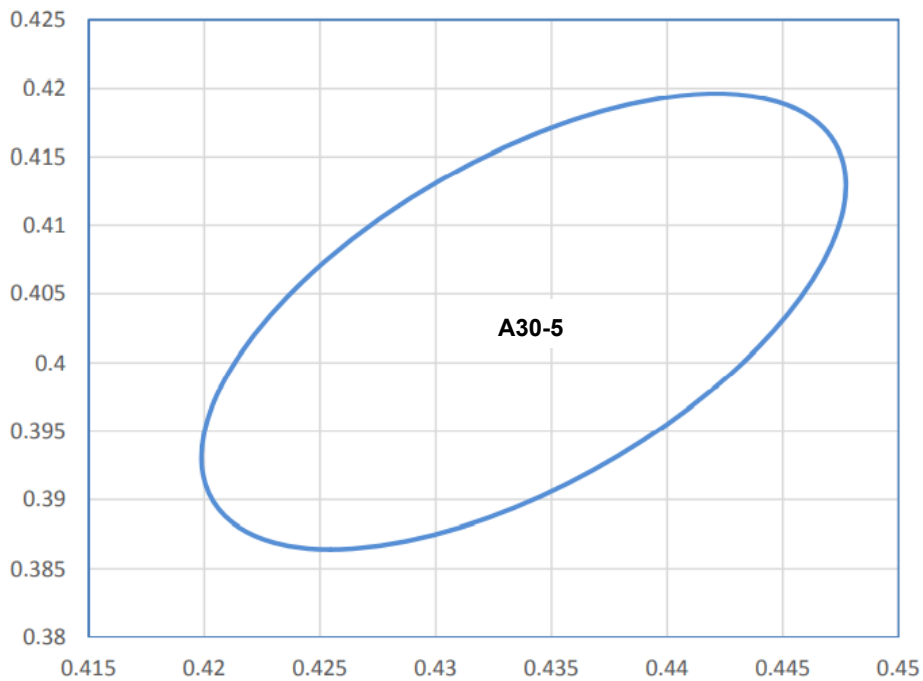
(2) Forward Voltage (Tj=25°C)

Rank	Condition	Min.	Max.	Unit
L3	60mA	66	68	V
L4		68	72	
L5		70	72	
L6		72	74	



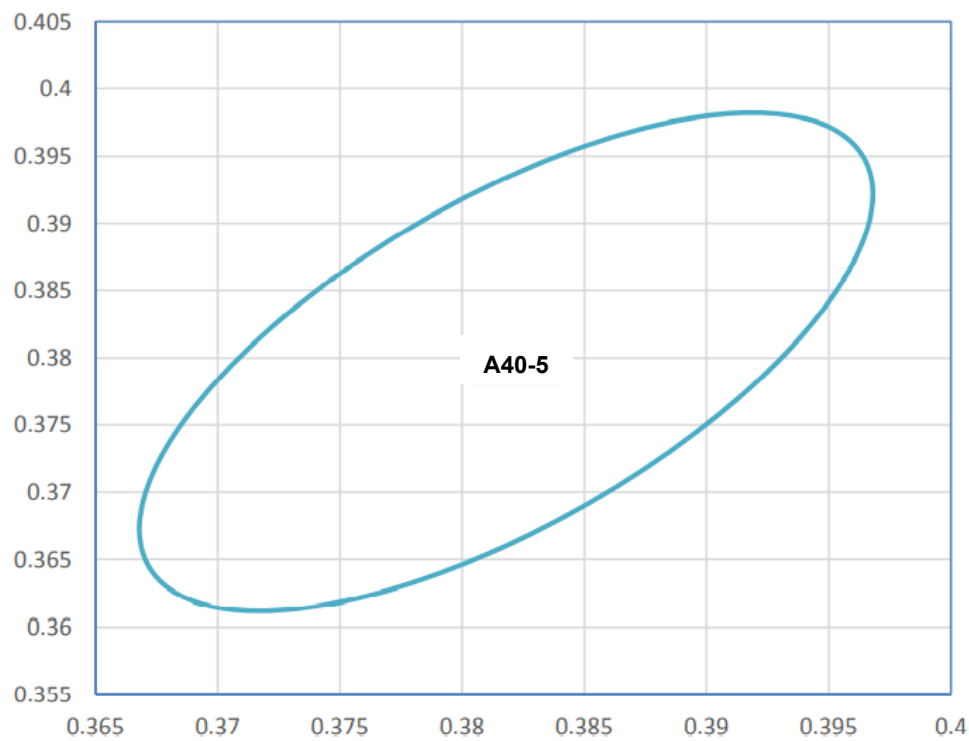
## (3) Chromaticity Bins

Rank		ES-2835-1072V-XX-830			
Bin Code		Color Coordinates(X,Y)			
A30-5	X	0.4338	A	0.0139	Theta°
	Y	0.4030	B	0.0068	53.22



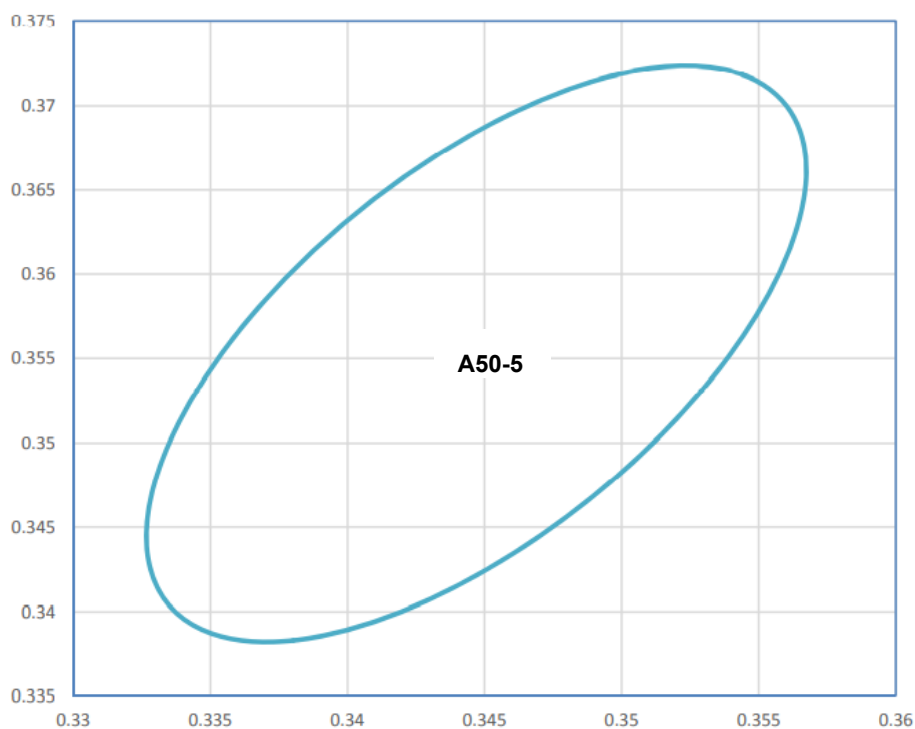
(3) Chromaticity Bins

Rank		ES-2835-1072V-XX-840			4000
Bin Code		Color Coordinates(X,Y)			
A40-5	X	0.3818	A	0.01565	Theta°
	Y	0.3797	B	0.0067	53.72



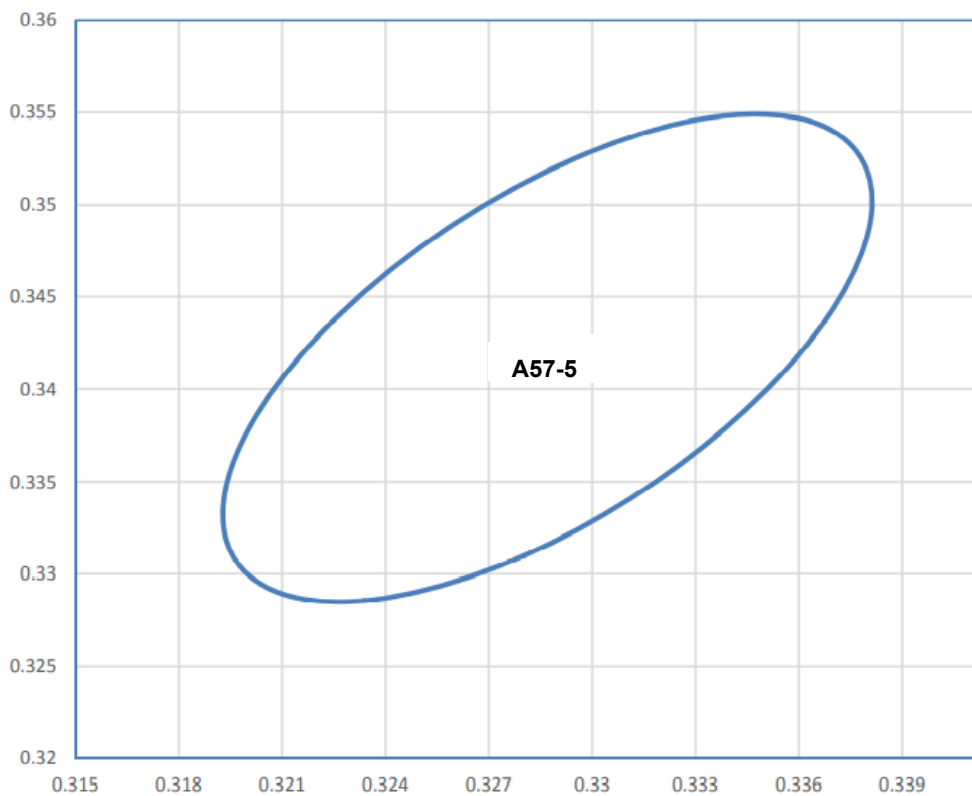
## (3) Chromaticity Bins

Rank	ES-2835-1072V-XX-850				5000
Bin Code	Color Coordinates(X,Y)				
A50-5	X	0.3447	A	0.0137	Theta°
	Y	0.3553	B	0.0059	59.62



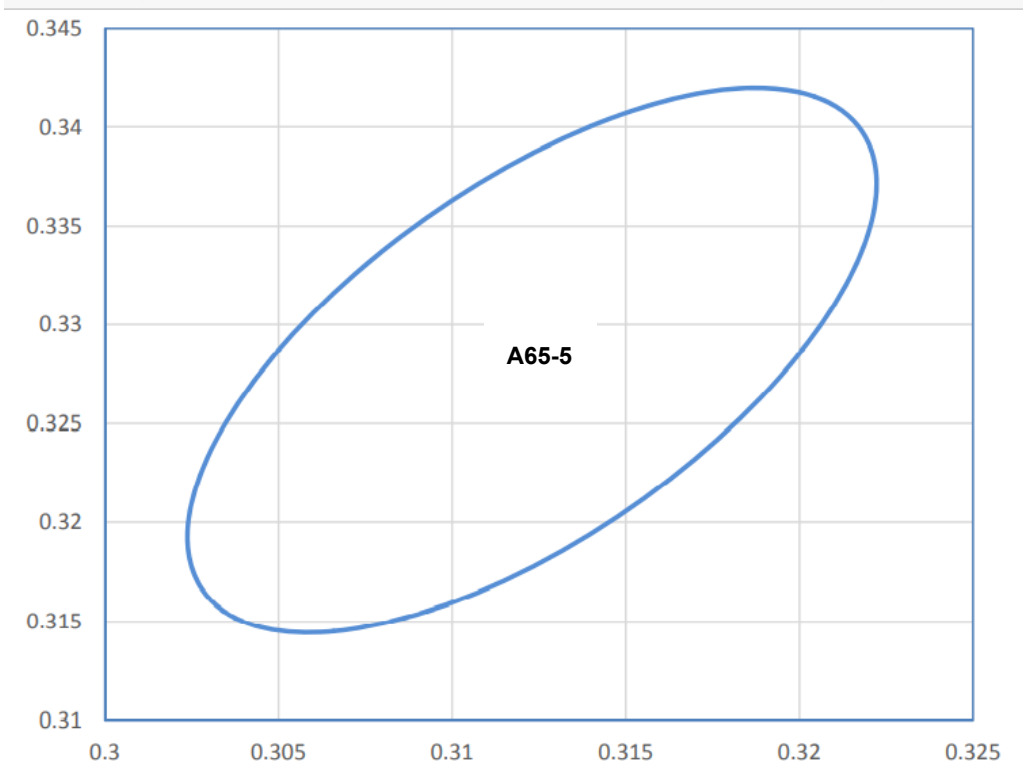
## (3) Chromaticity Bins

Rank		ES-2835-1072V-XX-857			5700
Bin Code		Color Coordinates(X,Y)			
A57-5	X	0.3287	A	0.01243	Theta°
	Y	0.3417	B	0.00533	59.09



(3) Chromaticity Bins

Rank		ES-2835-1072V-XX-865			6200
Bin Code		Color Coordinates(X,Y)			
A65-5	X	0.324	A	0.0149	Theta°
	Y	0.3436	B	0.0064	59.128



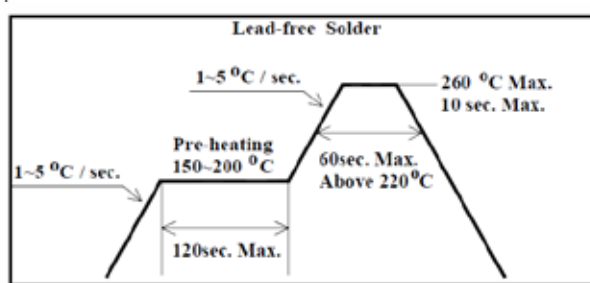
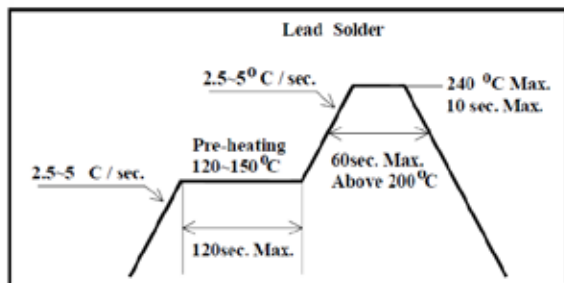
## REFLOW SOLDERING CHARACTERISTICS

Preheating  $140^{\circ}\text{C} \sim 160^{\circ}\text{C} \pm 5^{\circ}\text{C}$ , within 2 minutes.

Operation heating :  $260^{\circ}\text{C}$  (Max.) within 10 seconds. (Max)

Gradual Cooling (Avoid quenching).

Lead solder		Lead-free solder	
Pre-heat	120-150°C	Pre-heat	150-200°C
Pre-heat time	120 sec. Max.	Pre-heat time	120 sec. Max.
Peak Temperature	240°C Max.	Peak Temperature	260°C Max.
Soldering time condition	10 sec. Max.	Soldering time condition	10 sec. Max.

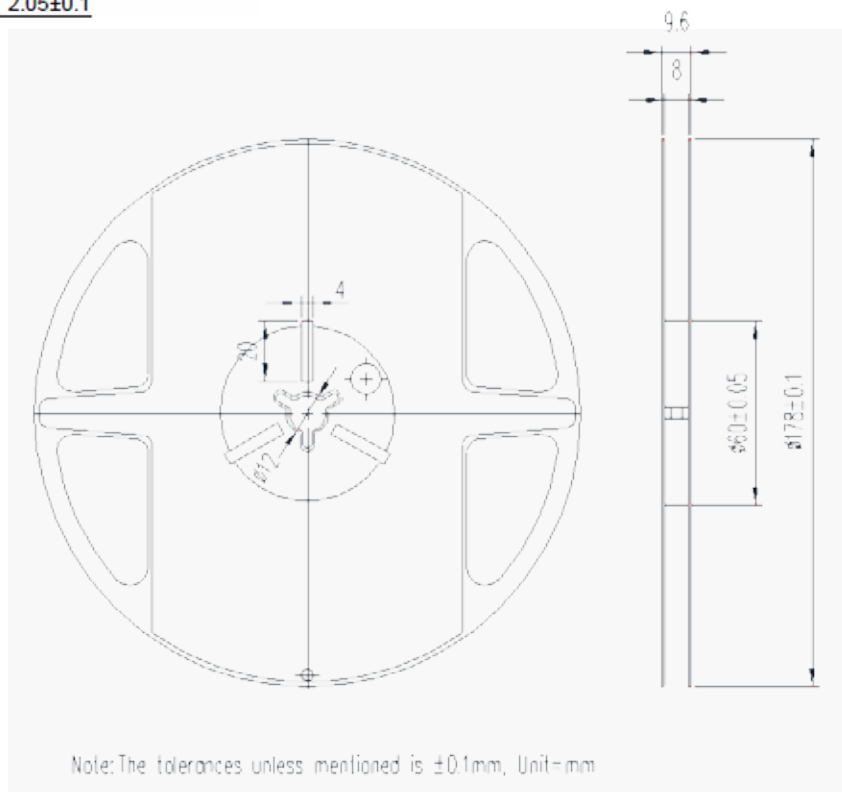
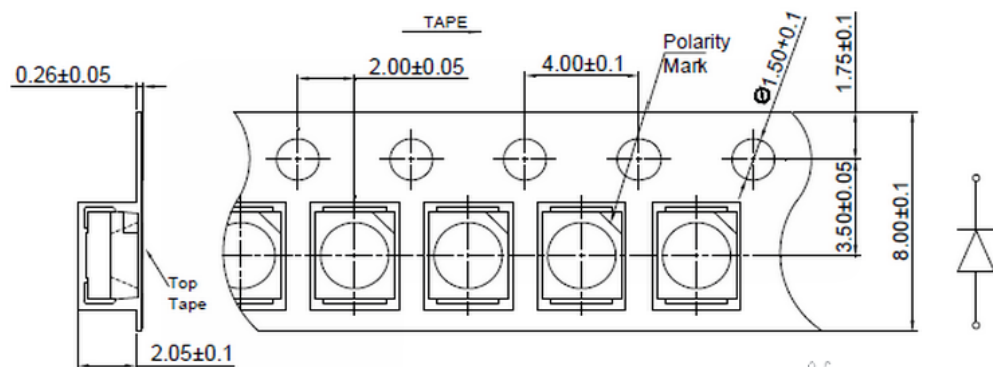


### Note:

The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs.

Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

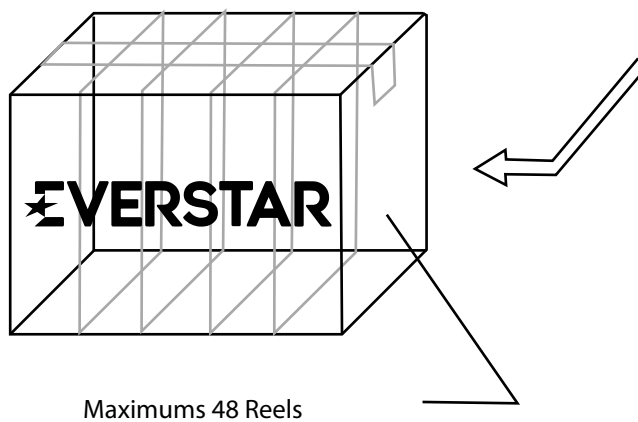
## TAPE AND REEL



Notes:

- (1) Quantity : 4,000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2\text{mm}$
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of  $10^\circ$  to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

## PACKAGING





## RELIABILITY TEST ITEMS

Test Items	Test Duration	Number of Damaged
Steady State Operating Life of High Temperature (HTOL) $T_s=85^{\circ}\text{C}$ , $I_F=\text{Max}$	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) $T_a=-40^{\circ}\text{C}$ , $I_F=\text{Max}$	1000hrs	0/20
Pulse Wet Operating Life of High Temperature (PWHTOL) $60^{\circ}\text{C}/90\%\text{RH}$ , $I_F 30\text{mins ON}/30\text{min OFF}$	500hrs	0/20
High Temperature Storage (HTS) $^{\circ}\text{C } 80^{\circ}\text{C}$	1000hrs	0/20
Low Temperature Storage (LTS) $-40^{\circ}\text{C}$	1000hrs	0/20
Thermal Shock (TS) $-45^{\circ}\text{C}\sim 125^{\circ}\text{C}$ 30min dwell 20sec transfer	100cycles	0/20
Solder Resistance (SR) $265^{\circ}\text{C}$ , 3X MSL	5sec	0/20
Solder Ability (SA) $245^{\circ}\text{C}$ 5sec, 95% coverage	5sec	0/11
Mechanical Shock (MS) 1500G 0.5msec pulse shock	Each 6 axis	0/6
Random Vibration (RV) 6G RMS, 10-2000Hz, 10min	Per axis	0/6
Variable Vibration Frequency (VVF) 10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis over	6hrs	0/6
Salt Spread (SS) $35^{\circ}\text{C}$ , 30g/m <sup>2</sup> /day	48hrs	0/11

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward Voltage	$V_F$	$I_F=\text{Typical Current}$		U.S.L x1.1
Luminous Flux	$I_m$	$I_F=\text{Typical Current}$	L.S.L x0.7	
CCX&CCY	x.y	$I_F=\text{Typical Current}$		Shift<0.02

## PRECAUTION FOR USE

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- (1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- (2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from EVERSTAR, a sealed container with a nitrogen atmosphere should be used for storage.
- (4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (5) The appearance and specifications of the product may be modified for improvement without notice.
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or antielectrostatic glove when handling the LEDs.
- (7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LEDs get unlighted at low current.